DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 20230 FGH-PW

Product Specification

Version: 2

GENERAL SPECIFICATION

MODULE NO.:

DEM 20230 FGH-PW

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	07.02.2013
1	CHANGE OPTICAL CHARACTERISTICS	21.02.2013
2	CHANGE DRAWING	09.04.2013

PREPARED BY: AH DATE: 09.04.2013

APPROVED BY: MH DATE: 09.04.2013

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1. Precautions in use of LCM

1.1 Use Modules

- 1. When modules switch On or Off, after accessing positive Supply Power with 5V±0.5V, then Input Signal Levels, if Signal Levels Input before Supply Power becomes stable or switches off, IC circuits off, modules will be damaged, as a result, modules will be damaged.
- 2. Dot Matrix Modules are high path number LCDs, they are largely related to the contrast, viewing angle, driving voltage when displaying, so you should adjust it to get best contrast and viewing angle, if it is too high, not only displays are effected, but also let life shorted.
- 3. When using under regulated working temperature below, the display responsiveness it too slow, when using under regulated temperature above, whole display surface turns dark, this is not damaged, when the temperature returns normal, all displays become normal

1.2 Module Storage

- 1. Storaging temperature:-30~+80°C
- 2. Place in dark sites to avoid strong lights
- 3. Don't place other thing on their surfaces
- 4. Packaged in polyer materials (with anti-static electricity layers) and sealed

1.3 Soldering

- 1. Iron head temperature: 280±10°C
- 2. Soldering time: <3-4S
- 3. Soldering material: eutectic nature, low melting point
- 4. Don't use acid solder
- 5. Soldering don't repeat above 3 times

2. Mechanical Specifications

Item	Value	Unit
Number of Characters	20 x 2	Character
Character Format	5x 8	Dots
Character Pitch	3.70 x 5.95	mm
Character Size	3.20 x 5.55	mm
Dot Size	0.60 x 0.65	mm
Dot Pitch	0.65 x 0.70	mm
Module Dimension	85.00 x 28.30 x 5.30	mm
Active Area	73.50 x 11.50	mm
Viewing Area	77.00 x 16.50	mm
Lcd Type	FSTN TRANSFLECTIVE / POSITIVE	-
Controller	NT7605H-BTDO1 (Novatek)	-
Duty	1/16	-
Bias	1/4	-
Viewing Direction	6:00	-
Backlight	LED, WHITE	-
Backlight Dimension	85.00 x 21.00 x 2.50	mm
Module Connection	Pins	-

3. Absolute Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit		
Power supply Voltage	VDD	-	-0.3	6.0	V		
Input voltage Range	VIN	-	-0.3	VDD+0.3	V		
Operating temperature	TOPR	-	-20	70	°C		
Storage temperature	TSTG	-	-30	80	°C		
Static electricity	Be sure that you are grounded when handling with LCM						

Notes: 1. Exceeding the absolute maximum ratings may cause permanent damage to the device. Functional operation under these conditions is not implied.

4. Backlight Characteristic

4.1 Electrical / optical specifications

Ta = 25°C

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Item	Symbol	Condition	Min.	Тур.	Max.	Unit		
Forward voltage	V_{f}	If=40mA, White	3.0	3.2	3.4	V		
LED *Luminous Intensity	$I_{ m V}$	If=40mA, White	300	400	-	cd/m2		
Chromaticity	X	If=40mA,	0.26	0.28	0.30			
Coordinate	y	White	0.26	0.28	0.30			
Reverse Current	I_R	VR=5V, White			40	uA		
Illuminance Power Deviation	ΔЕН	If=40mA, White	75			%		

Note: * Measured at the bare LED Backlight unit.

4.2 LED Maximum Operating Range

Item	Symbol	White	Unit
Power Dissipation	P_{AD}	170	mW
Forward Current	I_{F}	50	mA
Reverse Voltage	V _R	5	V

5. DC Electrical Characteristics (without LED Backlight)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Conditions	Applicable Pin
VDD	Operating Voltage	2.8	5.0	5.5	٧		
VIH1	"H" Level Input Voltage	0.8 Vpd	-	VDD	٧		DB0 – DB7,
VIL1	"L" Level Input Voltage	-0.3	-	0.2 VDD	٧		RS, R/W, E, OSC1
Vон1	"H" Level Output Voltage	VDD-0.6	-	-	٧	Іон = -1.2mA	DB0 – DB7
Vol1	"L" Level Output Voltage	-	-	GND+0.6	٧	IoL = 1.2mA	(CMOS)
Vсомп	Driver Voltage Descending (COM)	-	-	0.3	٧	Io = 5μA	COM1 - 16
Vsegd	Driver Voltage Descending (SEG)	-	-	0.3	٧	Io = 5μA	SEG1 - 100
I⊩	Input Leakage Current	-1	-	1	μА	VIN = 0 to VDD	
-IP	Pull-up MOS Current	50	125	250	μА	V _{DD} = 5V	RS, R/W, DB0-DB7
Іор	Supply Current Power Supply Current	-	1	1.5	mA	Rf oscillation, from external clock VDD = 5V, fosc = fcP = 540KHz, include LCD bias current.	Voo
External	Clock Operation						
fcp	External Clock Operating Frequency	250	540	700	KHz		
touty	External Clock Duty Cycle	45	50	55	%		
trcp	External Clock Rise Time	0.1	-	0.5	μs		
trcp	External Clock Fall Time	0.1	-	0.5	μs		
Internal (tor)						
fosc	Oscillator Frequency		540	700	KHz	Rf = 50KΩ (reference only)	
VLCD1 VLCD2	LCD Driving Voltage	3.0	-	VDD	٧	VDD - V ₅	

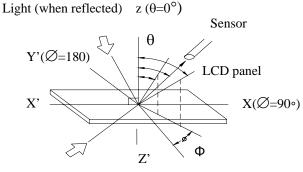
6. Optical Characteristics

1/16 duty, 1/4 bias, Vlcd=4.6V, Ta=25°C

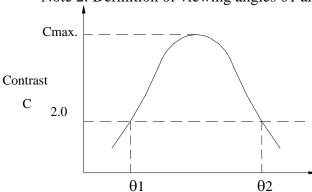
Item	Symbol	Conditions	Min.	Тур.	Max	Reference
	Vlcd=VDD-VO		4.3	4.6	4.9	V
Driving voltage		-20°C	4.45	4.75	5.05	V
Driving voltage	Vlcd	+25°C	4.3	4.6	4.9	V
		+70°C	4.15	4.45	4.75	V
Viewing angle	θ	C≥2.0,Ø=0°C	30°	-	-	Notes 1 & 2
Contrast	С	θ=5°, Ø=0°	3.0	-	-	Note 3
Response time(rise)	ton	θ=5°, Ø=0°	-		240ms	Note 4
Response time(fall)	toff	θ=5°, Ø=0°	-	ı	220ms	Note 4

Note 1: Definition of angles θ and \emptyset

Note 2: Definition of viewing angles $\theta 1$ and $\emptyset 2$



Light (when transmitted) $Y(\varnothing=0\circ)$ $(\theta=90\circ)$

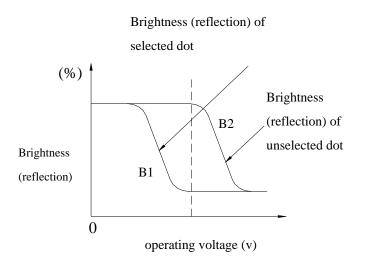


viewing angle θ (Φ fixed) Note: Optimum viewing angle with the naked eye and viewing angle θ at Cmax. Above are not always the same

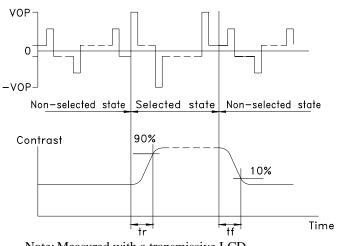
Note 3: Definition of contrast C

Brightness (reflection) of unselected dot (B2)

Brightness (reflection) of selected dot (B1)



Note 4: Definition of response time

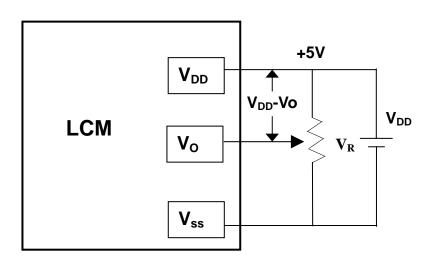


Note: Measured with a transmissive LCD panel which is displayed 1 cm²

 $\begin{array}{ll} V_{OPR} : Operating \ voltage & f_{FRM} : Frame \ frequency \\ t_{ON} & : Response \ time \ (rise) & t_{OFF} : Response \ time \ (fall) \end{array}$

7. Interface Pin Description

NO.	Symbol	Function				
1	GND	Ground (0V)				
2	VIN	Power Supply for Driving the LCD				
3	VDD	Power supply for Logic circuit				
4	RS	Data / Instruction select				
5	R/W	Read / Write select				
6	Е	Enable signal				
7-14	DB0-DB7	Data Bus line				



 V_{DD} -Vo : LCD Driving Voltage

V_R : 10k~20k

8. RELIABILITY

8.1 Reliability

Test item	Test condition	Evaluation and assessment
Operation at high temperature and humidity	40 °C±2 °C 90%RH for 500hours	No abnormalities in functions* and appearance**
Operation at high temperature	60 °C±2 °C for 500 hours	No abnormalities in functions* and appearance**
Heat shock	-20± ~ +60 °C Left for 1 hour at each temperature, transition time 5 min, repeated 10times	No abnormalities in functions* and appearance**
Low temperature	-20±2 °C for 500 hours	No abnormalities in functions* and appearance**
Vibration	Sweep for 1 min at 10 Hz, 55Hz, 10Hz, amplitude 1.5mm 2 hrs each in the X,Y and Z directions	No abnormalities in functions* and appearance**
Drop shock	Dropped onto a board from a height of 10cm	No abnormalities in functions* and appearance**

^{*} Dissipation current, contrast and display functions

8.2 Liquid Crystal Panel Service Life

100,000 hours minimum at $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$

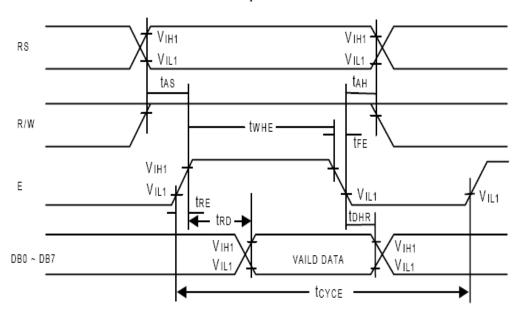
8.3 Definition of Panel Service Life

- Contrast becomes 30% of initial value
- Current consumption becomes three times higher than initial value
- Remarkable alignment deterioration occurs in LCD cell layer
- Unusual operation occurs in display functions

^{**} Polarizing filter deterioration, other appearance defects

9. Timing Characteristics

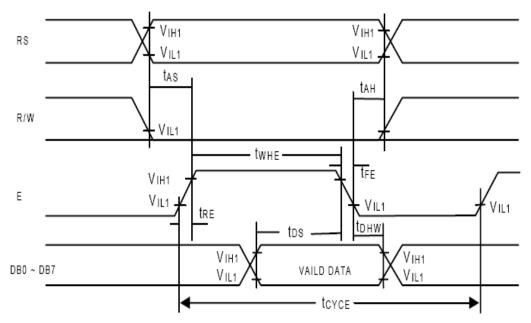
Read Operation



Read Cycle (Vpp = 5.0V, GND = 0V, TA = 25°C)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Conditions
toyce	Enable Cycle Time	500	-	-	ns	Figure 1
twhe	Enable "H" Level Pulse Width	300	-	-	ns	Figure 1
tre, tre	Enable Rise/Fall Time	-	-	25	ns	Figure 1
tas	RS, R/W Setup Time	60 ¹	-	-	ns	Figure 1
		100 ²				
tан	RS, R/W Address Hold Time	10	-	-	ns	Figure 1
tro	Read Data Output Delay	-	-	190	ns	Figure 1
tohr	Read Data Hold Time	20	-	-	ns	Figure 1

Write Operation



Write Cycle (VDD = 5.0V, GND = 0V, TA = 25°C)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Conditions
toyce	Enable Cycle Time	500	-	-	ns	Figure 2
twhe	Enable "H" Level Pulse Width	300	-	-	ns	Figure 2
tre, tre	Enable Rise/Fall Time	-	-	25	ns	Figure 2
tas	RS, R/W Setup Time	60 ¹	-	-	ns	Figure 2
		100 ²				
tah	RS, R/W Address Hold Time	10	-	-	ns	Figure 2
tos	Data Output Delay	100	-	-	ns	Figure 2
tohr	Data Hold Time	10	-	-	ns	Figure 2

Notes: 1: 8-bit operation mode 2: 4-bit operation mode

10. Display Command

Instruction					С	ode					Function	Execution time (max)
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		(f _{osc} = 250KHz)
Display Clear	0	0	0	0	0	0	0	0	0	1	Clear entire display area.	1.64ms
Display/ Cursor Home	0	0	0	0	0	0	0	0	1	*	Restore display from shift and load address counter with DD RAM address 00H.	1.64ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	s	Specify direction of cursor movement and display shift mode. This operation takes place after each data transfer (read/write).	40μs
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	Specify activation of display (D) cursor (C) and blinking of character at cursor position (B).	40μs
Display/ Cursor Shift	0	0	0	0	0	1	S/C	R/L	*	*	Shift display or move cursor.	40μs
Function Set	0	0	0	0	1	DL	N	F	*	*	Set interface data length (DL), number of display line (N), and character font (F).	40μs
RAM Address Set	0	0	0	1			AC	CG			Load the address counter with a CG RAM address. Subsequent data access is for CG RAM data.	40μs
DD RAM Address Set	0	0	1				ADD				Load the address counter with a DD RAM address. Subsequent data access is for DD RAM data.	40μs
Busy Flag/ Address Counter Read	0	1				А	.C				Read Busy Flag (BF) and contents of Address Counter (AC).	40μs
CG RAM/ DD RAM Data Write	1	0				Write	e data				Write data to CG RAM or DD RAM.	40μs
CG RAM/ DD RAM Data Read	1	1				Read	l data				Read data from CG RAM or DD RAM.	40μs
	S = D = C = B = S/C = R/L = DL = BF = B	I/D = 1 : Increment									DD RAM : Display Data RAM CG RAM : Character Generator RAM ACG : Character Generator RAM Address ADD : Display Data RAM Address AC : Address Counter	

Note 1: Symbol "*" signifies an insignificant bit (disregard). Note 2: Correct input value for "N" is predetermined for each model.

11. Character Pattern

T.T														
Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	HLLL	HLLH	HLHL	нілн	ннін	нннг	нннн
LLLL														
LLLH														
LLHL														
LLHH														
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12. LCD Dimensions

